

Low Power ZigBee Module (Atmel)

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DOCUMENT HISTORY

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TABLE OF CONTENTS

| | | |
|----------|---|----------|
| 1 | INTRODUCTION..... | 3 |
| 1.1 | PURPOSE | 3 |
| 1.2 | SCOPE..... | 3 |
| 1.3 | INTENDED AUDIENCE | 3 |
| 1.4 | DEFINITIONS AND ABBREVIATIONS..... | 3 |
| 2 | OVERVIEW..... | 4 |
| 3 | CONSTRAINTS, ASSUMPTIONS, AND DEPENDENCIES | 5 |
| 4 | FEATURES..... | 6 |
| 5 | BLOCK DIAGRAM AND PORT FUNCTION | 7 |
| 5.1 | UART PORT | 7 |
| 5.2 | PROGRAMMING AND DEBUG PORT..... | 7 |
| 5.3 | GPIO PORT | 7 |
| 6 | DETAIL SPECIFICATIONS | 8 |
| 6.1 | PIN ASSIGNMENT | 8 |
| 6.1.1 | <i>LPZigBee Module</i> | 8 |
| 6.2 | THE PCB OUTLINE FOR LPZIGBEE MODULE | 9 |
| 6.3 | ELECTRICAL SPECIFICATION | 10 |
| 6.3.1 | <i>DC power supply range</i> | 10 |
| 6.3.2 | <i>System dBm max & min (maximum and minimum TX output at PCB antenna) and System current & power drawn</i> | 10 |
| 6.3.3 | <i>System current & power drawn of TX@20dBm and RX</i> | 10 |
| 6.3.4 | <i>System Current and Power consumption during idle and hibernate mode</i> | 10 |
| 6.3.5 | <i>System RX Sensitivity (dBm)</i> | 11 |

1 INTRODUCTION

1.1 PURPOSE

The purpose of this document is to provide the product manual and Design Specifications for low power ZigBee (LPZigBee) module.

1.2 SCOPE

The scope of this document is to produce the detail design of LPZigBee module.

1.3 INTENDED AUDIENCE

This document is intended primarily for the EE Hardware Design.

1.4 DEFINITIONS AND ABBREVIATIONS

| Term | Meaning |
|------------------|---|
| ADC | Analog to Digital Converter |
| GPIO | General Purpose Input/Output |
| I ² C | Inter Integrated Circuit |
| JTAG | Joint Test Action Group |
| FEM | Front-end module |
| SPI | Serial Peripheral Interface |
| UART | Universal Asynchronous Receiver Transmitter |
| NF | Noise figure |
| LPZigBee | Low power Zigbee Module |

2 OVERVIEW

LPZigBee module mainly consists of three sections: the microcontroller ATXmega256D3 and periphery, the radio transceiver AT86RF231 and the RF front-end with power amplifier and low-pass filtering.

The ATXmega256D3 controls the AT86RF231 radio transceiver and serves as an SPI master. The radio transceiver handles all actions concerning RF modulation/demodulation, signal processing, frame reception and transmission. MAC hardware acceleration functions are implemented in the radio transceiver, too.

Further information about the radio transceiver and the microcontroller are available in the appropriate datasheets, refer to 1.5 references.

The RF front-end incorporates signal amplification and filtering of the transmit signal. The degree of filtering depends on operating conditions as well as regional aspects. Switching between reception and transmission is directly controlled by the radio transceiver.

3 CONSTRAINTS, ASSUMPTIONS, AND DEPENDENCIES

- (1) Unless otherwise specified, all resistors, capacitors, inductors, & ferrite beads are 0402 size
- (2) C202, C400, L200, and L300 are 0603 size
- (3) The operating temperature range for all electrical components of LPZigBee module is **-40°C** to **+85°C**.
- (4) **With FEM function:** remove R200 & R203 & R208 and install R201 & R205 & R207
- (5) **Bypass FEM function for MMCX:** remove U201 & R201 & R205, R207 & R202 & R204 & C200 & C201 & C202 & C203 and install R200 & R203 & R208
- (6) **Bypass FEM function for PCB Antenna:** remove U201 & R207 & R201 & R202 & R204 & R208 & C200 & C201 & C202 & C203 and install R200 & R203 & R205
- (7) The impedances of Nets (RF_1, RF_2, RF_FEM, RF_BYPASS, ANT_1, ANT_2, ANT_F, and MMCX) are 50 ohm in PCB layout.
- (8) The following clocks of Nets (SPI_CLK, I2C_SCL, SCLK, MEM_SCK, CLKM and CLK_OUT) should follow the 3W rule for layout.

4 FEATURES

- Ultra compact size
- High RX sensitivity (-103 dBm)
- Outperforming link budget (123 dB)
- Up to +20 dBm output power
- Very low power consumption:
 - <6 μ A in Sleep mode,
 - 18 mA in RX mode,
 - 132 mA in TX mode@Pout is +20 dBm
- Ample memory resources (256 bytes of flash memory, 16K bytes RAM, 4K bytes EEPROM)
- Wide range of interfaces (both analog and digital):
 - 8 spare GPIO,
 - 2 ADC lines
 - UART
 - I2C
 - SPI
 - JTAG
- Capability to use MAC address written into EEPROM
- IEEE 802.15.4 compliance
- 2.4 GHz ISM band
- BitCloud embedded software, including UART bootloader and AT command set

5 BLOCK DIAGRAM AND PORT FUNCTION

5.1 UART PORT

LPZigBee Module provides four signals (RX, TX) of standard RS-232 protocol to support user applications. The UART port is set the DCE port and connected with other devices by D-Sub-9 Female connector. But the RX, TX connection between RS-232 Transceiver and D-Sub-9 Female connector can be reversed by Jumpers, allowing use of connecting straight-through or cross-wires cable.

5.2 PROGRAMMING AND DEBUG PORT

The LPZigBee module can be programmed and debugged by JTAG port. It is a 20 pins header and connects with Atmel's debugging tool.

5.3 GPIO PORT

The GPIO connectors provide the SPI, I2C, UART and GPIO interface for external system testing. The recommended operation voltage is +3.3Vdc.

6 DETAIL SPECIFICATIONS

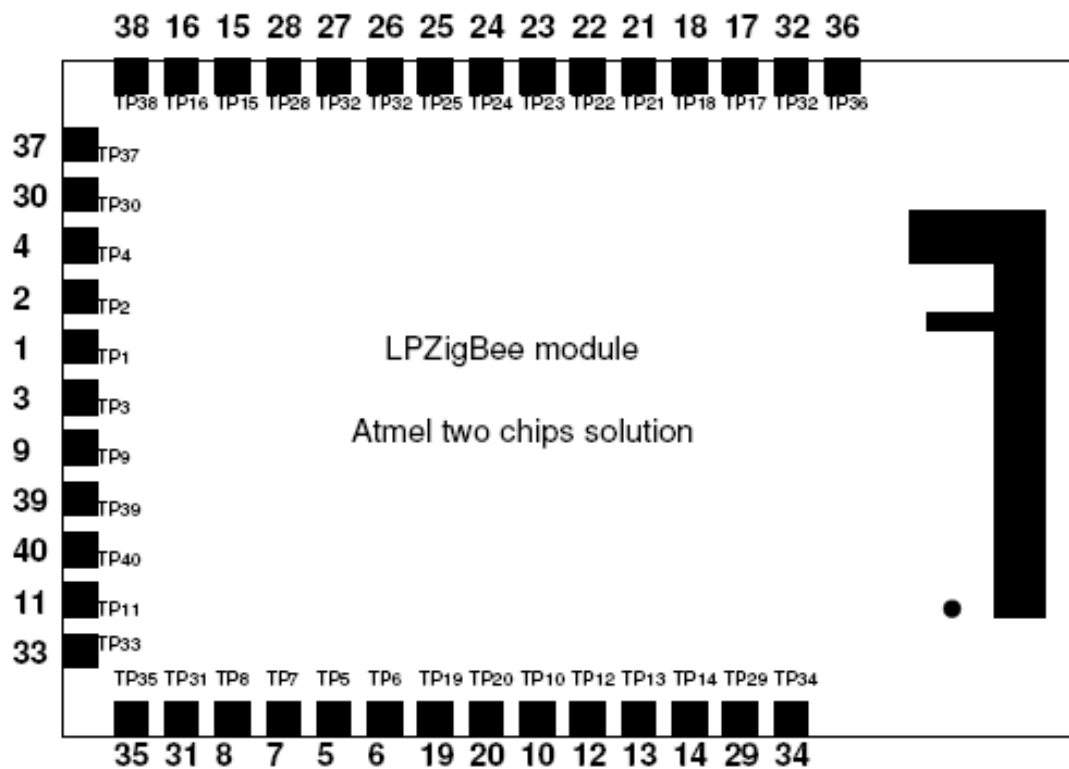
6.1 PIN ASSIGNMENT

6.1.1 LPZigBee Module

| Pin | Signal | Connection for 2-chip solution (ATxmega256D3) |
|-----|--------------|--|
| 1 | SPI_MISO | PD6/MISO |
| 2 | SPI_MOSI | PD5/MOSI |
| 3 | SPI_SCK | PD7/SCK |
| 4 | SPI_SS_L | PD4/SSN |
| 5 | UART_RXD | PE2/RXD0 |
| 6 | UART_TXD | PE3/TXD0 |
| 7 | I2C_SCL | PE1/SCL |
| 8 | I2C_SDA | PE0/SDA |
| 9 | JTAG_TCK | nc |
| 10 | JTAG_TMS | nc |
| 11 | JTAG_TDO | nc |
| 12 | JTAG_TDI/PDI | PDI |
| 13 | RESET_L | RESET |
| 14 | CLK_OUT | PR0/xtal1 |
| 15 | ADC1 | PB0/ACD8 |
| 16 | ADC2 | PB1/ACD9 |
| 17 | PWM1_DC1 | PF0/OC0A |
| 18 | PWM1_DC2 | PF1/OC0B |
| 19 | PWM2_DC1 | PE4/OC1A |
| 20 | PWM2_DC2 | PE5/OC1B |
| 21 | GPIO1 | PF2/INT/OC0C |
| 22 | GPIO2 | PF3/INT/OC0D |
| 23 | GPIO3 | PF4/INT |
| 24 | GPIO4 | PF5/INT |
| 25 | GPIO5 | PF6/INT |
| 26 | GPIO6 | PF7/INT |
| 27 | GPIO7 | PB2/INT/ADC10 |
| 28 | GPIO8 | PB3/INT/ADC11 |
| 29 | VCC | Power Plane |
| 30 | VCC | Power Plane |
| 31 | VCC | Power Plane |
| 32 | VCC | Power Plane |
| 33 | GND | Ground Plane |
| 34 | GND | Ground Plane |
| 35 | GND | Ground Plane |
| 36 | GND | Ground Plane |
| 37 | GND | Ground Plane |

| | | |
|----|--------|--------------|
| 38 | GND | Ground Plane |
| 39 | SPARE1 | |
| 40 | SPARE2 | |

6.2 THE PCB OUTLINE FOR LPZigBEE MODULE



6.3 ELECTRICAL SPECIFICATION

6.3.1 DC power supply range

| System module | power supply range |
|---|--|
| Ateml solution w/o FEM | 1.8~3.6V |
| Ateml solution with SE2431L@ NF of LNA=2 dB Gain of LNA=12.5 dB | 1.8~3.6V (Transceiver) 2.0~3.6V (FEM) |

6.3.2 System dBm max & min (maximum and minimum TX output at PCB antenna) and System current & power drawn.

| System module | maximum TX output | minimum TX output |
|---|--------------------|--------------------|
| Ateml solution w/o FEM | 2.1dBm@I=14mA | (-17.9)dBm@I=7.4mA |
| Ateml solution with SE2431L@ NF of LNA=2 dB Gain of LNA=12.5 dB | 21dBm@Icc=134.13mA | 5.6dBm@>37.4mA |

6.3.3 System current & power drawn of TX@20dBm and RX

| System module | TX@20dBm | RX |
|---|-------------|-----------|
| Ateml solution w/o FEM | NA | I=12.3 mA |
| Ateml solution with SE2431L@ NF of LNA=2 dB Gain of LNA=12.5 dB | I=130.83 mA | I=17.3 mA |

6.3.4 System Current and Power consumption during idle and hibernate mode

| System module | Idle mode | Hibernate mode |
|---|-------------|----------------|
| Ateml solution w/o FEM | 7mA @ 32MHz | 100nA |
| Ateml solution with SE2431L@ NF of LNA=2 dB Gain of LNA=12.5 dB | 7mA @ 32MHz | 100nA |

6.3.5 System RX Sensitivity (dBm)

| System module | Sensitivity (dBm) |
|---|----------------------|
| Ateml solution w/o FEM | (-99.6) |
| Ateml solution with SE2431L@ NF of LNA=2 dB Gain of LNA=12.5 dB | (-103.63) |

Federal Communication Commission Interference Statement

This module has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

FCC Caution: Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate this equipment.

IMPORTANT NOTE:

FCC Radiation Exposure Statement:

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator & your body.

This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter.

This device is intended only for OEM integrators under the following conditions:

- 1) The antenna must be installed such that 20 cm is maintained between the antenna and users, and
- 2) The transmitter module may not be co-located with any other transmitter or antenna,

As long as 2 conditions above are met, further transmitter test will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc.).

IMPORTANT NOTE: In the event that these conditions can not be met (for example certain laptop configurations or co-location with another transmitter), then the FCC authorization is no longer considered valid and the FCC ID can not be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

End Product Labeling

This transmitter module is authorized only for use in device where the antenna may be installed such that 20 cm may be maintained between the antenna and users. The final end product must be labeled in a visible area with the following: “Contains FCC ID: ZAR-TGPBA0010290”.

Manual Information To the End User

The OEM integrator has to be aware not to provide information to the end user

regarding how to install or remove this RF module in the user’s manual of the end product which integrates this module.

The end user manual shall include all required regulatory information/warning as show in this manual.